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TID #: PMP10610	Project Title: LM3481 Automotive 12W SEPIC		
Number: PMP10610	Rev: 3	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: [No Variations]		
Drawn By:	File: PMP10610_sch_rev3.SchDoc	Size: B	
Engineer: X Fang	Contact: http://www.ti.com/support	Sheet: 1 of 2	

H1 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H5 1902C H6 1902C H7 1902C H8 1902C

FID1 FID2 FID3

PCB Number: PMP10610
PCB Rev: A


PCB
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ZZ1
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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TID #: PMP10610	Project Title: LM3481 Automotive 12W SEPIC		
Number: PMP10610	Rev: 3	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 2 of 2	
Drawn By:	File: PMP10610_TID_Hardware.SchDoc	Size: B	
Engineer: X Fang	Contact: http://www.ti.com/support		

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